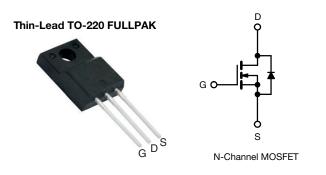
## SiHA21N65EF

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**Vishay Siliconix** 

# **E Series Power MOSFET with Fast Body Diode**



PRODUCT SUMMARY					
V <sub>DS</sub> (V) at T <sub>J</sub> max.	700				
R <sub>DS(on)</sub> max. (Ω) at 25 °C	V <sub>GS</sub> = 10 V 0.18				
Q <sub>g</sub> max. (nC)	106				
Q <sub>gs</sub> (nC)	14				
Q <sub>gd</sub> (nC)	33				
Configuration	Single				

#### FEATURES

- Fast body diode MOSFET using E series technology
- Reduced t<sub>rr</sub>, Q<sub>rr</sub>, and I<sub>RRM</sub>
- Low figure-of-merit (FOM) Ron x Qg
- Low input capacitance (Ciss)
- Low switching losses due to reduced Q<sub>rr</sub>
- Ultra low gate charge (Q<sub>g</sub>)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

#### **APPLICATIONS**

- Telecommunications
- Server and telecom power supplies
- Lighting
- High-intensity discharge (HID) - Fluorescent ballast lighting
- Consumer and computing
- ATX power supplies
- Industrial
- Welding
  - Battery chargers
- Renewable energy
   Solar (PV inverters)
- Switch mode power supplies (SMPS)
- Applications using the following topologies
  - LCC
  - Phase shifted bridge (ZVS)
  - 3-level inverter
  - AC/DC bridge

ORDERING INFORMATION					
Package	Thin-Lead TO-220 FULLPAK				
Lead (Pb)-free	SiHA21N65EF-E3				
Lead (Pb)-free and halogen-free	SiHA21N65EF-GE3				

<b>ABSOLUTE MAXIMUM RATINGS</b> ( $T_C = 25 \degree C$ , unless otherwise noted)						
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage			V <sub>DS</sub>	650	V	
Gate-source voltage			V <sub>GS</sub>	± 30		
Continuous drain current (T <sub>.1</sub> = 150 °C) $^{\circ}$	V <sub>GS</sub> at 10 V	$T_{C} = 25 \text{ °C}$ $T_{C} = 100 \text{ °C}$	- I <sub>D</sub> -	21		
Continuous drain current $(I_J = 150 \text{ C})^3$	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 100 °C		13	A	
Pulsed drain current <sup>a</sup>			I <sub>DM</sub>	53	1	
Linear derating factor				0.28	W/°C	
Single pulse avalanche energy <sup>b</sup>			E <sub>AS</sub>	367	mJ	
Maximum power dissipation			PD	35	W	
Operating junction and storage temperature range			T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C	
Drain-source voltage slope	$T_{\rm J} = 1$	125 °C	d\//dt	37	1//20	
Reverse diode dV/dt <sup>d</sup>			dV/dt	31	V/ns	
Soldering recommendations (peak temperature) <sup>c</sup>	for 10 s			300	°C	
Mounting torque	M3 s	screw		0.6	Nm	

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

b.  $V_{DD}$  = 50 V, starting T<sub>J</sub> = 25 °C, L = 28.2 mH, R<sub>g</sub> = 25  $\Omega$ , I<sub>AS</sub> = 5.1 A

c. 1.6 mm from case

d.  $I_{SD} \leq I_D$ , dl/dt = 100 A/µs, starting  $T_J$  = 25 °C

e. Limited by maximum junction temperature

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PARAMETER	SYMBOL	TYP.		MAX.		UNIT			
Maximum junction-to-ambient	R <sub>thJA</sub>	-	- 65						
Maximum junction-to-case (drain)	R <sub>thJC</sub>	- 3.6			°C/W				
<b>SPECIFICATIONS</b> ( $T_J = 25 \degree C$ ,	unless otherwi	ise noted)							
PARAMETER	SYMBOL	1	T CONDITIONS		MIN.	TYP.	MAX.	UNI	
Static	OTTIBOL	120					111/03		
Drain-source breakdown voltage	V <sub>DS</sub>	Voo	= 0 V, I <sub>D</sub> = 250 µ	ιA	650	-	-	V	
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_J$		e to 25 °C, I <sub>D</sub> =		-	0.67	-	V/°(	
Gate-source threshold voltage (N)	V <sub>GS(th)</sub>	-	= V <sub>GS</sub> , I <sub>D</sub> = 250 µ		2	-	4	V	
date-source threshold voltage (N)	V GS(th)		$V_{GS} = \pm 20 V$		-	_	+ + 100	nA	
Gate-source leakage	I <sub>GSS</sub>		$V_{GS} = \pm 20 V$ $V_{GS} = \pm 30 V$		_	_	± 100		
	1			V	-	-	1 ± 1	μA	
Zero gate voltage drain current	I <sub>DSS</sub>		$V_{DS} = 520 \text{ V}, V_{GS} = 0 \text{ V}$ $V_{DS} = 520 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 125 \text{ °C}$		-	-	500	μA	
Drain-source on-state resistance	R <sub>DS(on)</sub>	V <sub>DS</sub> = 320 V V <sub>GS</sub> = 10 V	l <sub>D</sub> = 1		-	0.15	0.18	Ω	
Forward transconductance	g <sub>fs</sub>		= 30 V, I <sub>D</sub> = 11		-	7.0	-	S	
Dynamic	915						ļ	<u> </u>	
Input capacitance	C <sub>iss</sub>	$V_{GS} = 0 \text{ V},$ $V_{DS} = 100 \text{ V},$ $f = 1 \text{ MHz}$		_	2322	-	pF		
Output capacitance	C <sub>oss</sub>			-	105	-			
Reverse transfer capacitance	C <sub>rss</sub>			-	4	-			
Effective output capacitance, energy		$V_{\rm DS}$ = 0 V to 520 V, $V_{\rm GS}$ = 0 V							
related <sup>a</sup>	C <sub>o(er)</sub>			-	84	-			
Effective output capacitance, time related <sup>b</sup>	C <sub>o(tr)</sub>			-	293	-			
Total gate charge	Qg	V <sub>GS</sub> = 10 V I <sub>D</sub> = 11 A, V <sub>DS</sub> = 520 V		-	71	106	nC		
Gate-source charge	Q <sub>gs</sub>			-	14	-			
Gate-drain charge	Q <sub>gd</sub>				-	33	-	1	
Turn-on delay time	t <sub>d(on)</sub>				-	22	44		
Rise time	t <sub>r</sub>	$V_{DD}$ = 520 V, I_D = 11 A, $V_{GS}$ = 10 V, R_g = 9.1 $\Omega$		-	34	68	- ns		
Turn-off delay time	t <sub>d(off)</sub>			-	68	102			
Fall time	t <sub>f</sub>			-	42	84			
Gate input resistance	R <sub>g</sub>	f = 1 MHz, open drain		-	0.78	-	Ω		
Drain-Source Body Diode Characterist									
Continuous source-drain diode current	I <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		-	-	21			
Pulsed diode forward current	I <sub>SM</sub>			-	-	53	A		
Diode forward voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °C, I <sub>S</sub> = 11 A, V <sub>GS</sub> = 0 V		-	0.9	1.2	V		
Reverse recovery time	t <sub>rr</sub>	$T_{J} = 25 \text{ °C}, I_{F} = I_{S} = 11 \text{ A}, \\ dI/dt = 100 \text{ A}/\mu\text{s}, V_{R} = 25 \text{ V}$		-	160	-	ns		
Reverse recovery charge	Q <sub>rr</sub>			-	1.2	-	μΟ		
Reverse recovery current	I <sub>RRM</sub>			-	14	-	A		

#### Notes

a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ 

b.  $C_{oss(tr)}$  is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ 



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## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

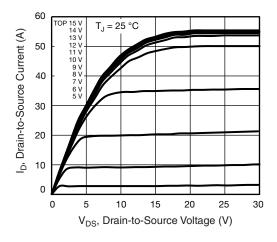


Fig. 1 - Typical Output Characteristics

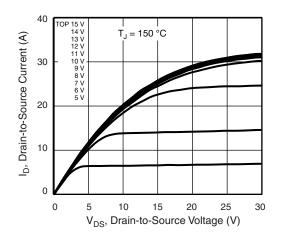
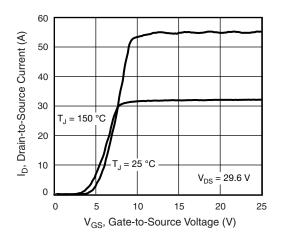


Fig. 2 - Typical Output Characteristics





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3 R<sub>DS(on)</sub>, Drain-to-Source On Resistance (Normalized) 2.5 2 1.5 10 1 ٧ V<sub>GS</sub> 0.5 0 - 60 - 40 -20 0 20 40 60 80 100 120 140 160 T<sub>J</sub>, Junction Temperature (°C)

Fig. 4 - Normalized On-Resistance vs. Temperature

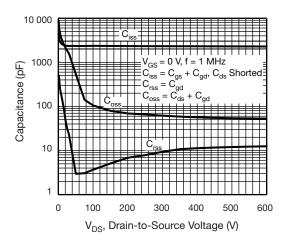


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

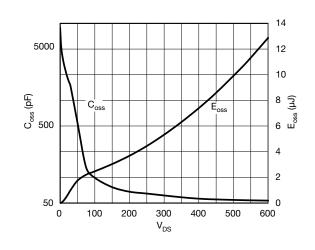


Fig. 6 -  $C_{\text{oss}}$  and  $E_{\text{oss}}$  vs.  $V_{\text{DS}}$ 

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24 V<sub>DS</sub> = 520 V V<sub>GS</sub>, Gate-to-Source Voltage (V) V<sub>DS</sub> = 325 V 20 V<sub>DS</sub> = 130 V = 16 12 8 4 0 0 30 60 90 120 150 Q<sub>q</sub>, Total Gate Charge (nC)

Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

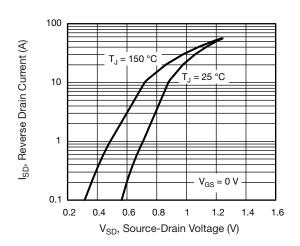


Fig. 8 - Typical Source-Drain Diode Forward Voltage

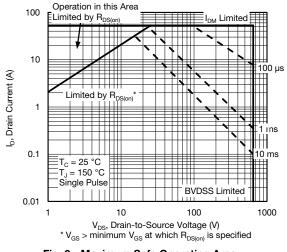


Fig. 9 - Maximum Safe Operating Area

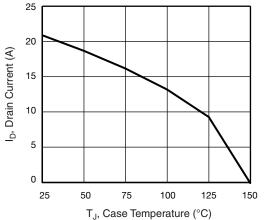


Fig. 10 - Maximum Drain Current vs. Case Temperature

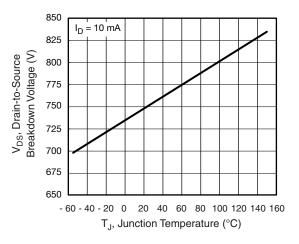
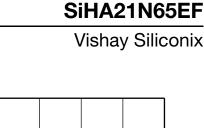


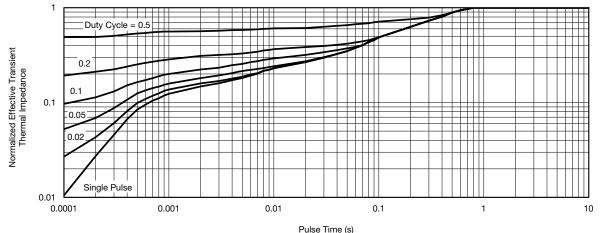
Fig. 11 - Temperature vs. Drain-to-Source Voltage





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Puise Time (s)



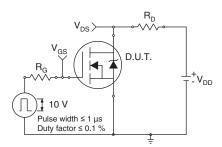


Fig. 13 - Switching Time Test Circuit

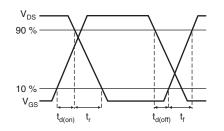


Fig. 14 - Switching Time Waveforms

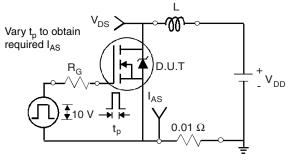


Fig. 15 - Unclamped Inductive Test Circuit

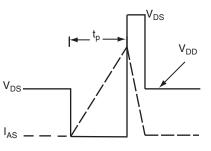


Fig. 16 - Unclamped Inductive Waveforms

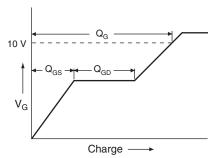


Fig. 17 - Basic Gate Charge Waveform

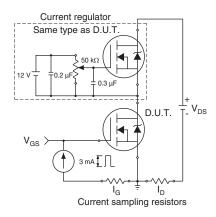


Fig. 18 - Gate Charge Test Circuit

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### Peak Diode Recovery dV/dt Test Circuit

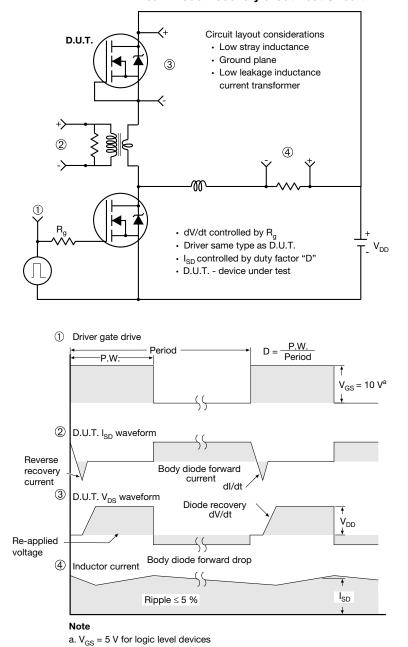


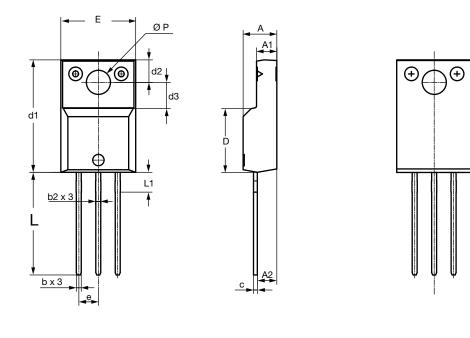
Fig. 19 - For N-Channel

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# **TO-220 FULLPAK Thin Lead**





		DIMEN	ISIONS	
SYMBOL	MILLIN	METERS	INC	HES
	MIN.	MAX.	MIN.	MAX.
А	4.30	4.70	0.169	0.185
A1	2.50	2.90	0.098	0.114
A2	2.40	2.80	0.094	0.110
b	0.60	0.80	0.024	0.031
b2	0.60	0.90	0.024	0.035
С	-	0.60	-	0.024
D	8.30	8.70	0.327	0.342
d1	14.70	15.30	0.579	0.602
d2	2.90	3.10	0.114	0.122
d3	3.30	3.70	0.130	0.146
E	9.70	10.30	0.382	0.406
е	2.50	2.70	0.098	0.106
L	13.40	13.80	0.528	0.543
L1	1.00	2.80	0.039	0.110
ØP	3.00	3.40	0.118	0.134
ECN: E20-0684-Rev. D, 28 DWG: 6021	3-Dec-2020	·	·	



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